

2202664

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DIN rail housing, Lower housing part with metal foot catch, with vents, width: 75.87 mm, height: 120.6 mm, depth: 64.3 mm, color: light grey (similar RAL 7035), cross connection: DIN rail connector (optional), number of positions cross connector: 5 or 8

Your advantages

- · Easy, tool-free mounting
- · Optional DIN rail connector for easy module-to-module communication
- · Lock and Release principle for automatic latching and intuitive release of the front connection plug
- · Plastic in accordance with UL94 V0: for more rigorous flammability requirements
- · Wide design: ideal for integrating TFT displays for controllers

Commercial data

Item number	2202664
Packing unit	10 pc
Minimum order quantity	10 pc
Sales key	AC15
Product key	ACHEBA
GTIN	4055626199306
Weight per piece (including packing)	83.88 g
Weight per piece (excluding packing)	83.88 g
Customs tariff number	85389099
Country of origin	DE



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Technical data

Notes

General	Refer to the data sheet for the range in the download area.
General	Material of contact pads for bus connector, galvanic gold (hard gold)

Product properties

Product type	Enclosure bottom part
Housing series	ME-IO
Max. number of positions	192 (pitch: 3.45 mm)
	128 (pitch: 5 mm)
Туре	Lower housing part with metal foot catch
Housing type	DIN rail housing
Ventilation openings present	yes

Dimensions

Width 75.87 mm Height 120.6 mm Depth 64.3 mm Depth from top edge of DIN rail 57.7 mm PCB design PCB thickness 1.4 mm 1.8 mm	Dimensional drawing	h w	
Depth 64.3 mm Depth from top edge of DIN rail 57.7 mm PCB design	Width	75.87 mm	
Depth from top edge of DIN rail 57.7 mm PCB design	Height	120.6 mm	
PCB design	Depth	64.3 mm	
	Depth from top edge of DIN rail	57.7 mm	
PCB thickness 1.4 mm 1.8 mm	PCB design		
	PCB thickness	1.4 mm 1.8 mm	

Material specifications

Color (Housing)	light grey (RAL 7035)
Flammability rating according to UL 94	V0
CTI according to IEC 60112	600
Surface characteristics	untreated
Housing material	Polyamide

Environmental and real-life conditions

Power dissipation single housing for 20 °C

Ambient temperature	20 °C
Reduction factor	1



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Mechanical strength / tumbling barrel

Mounting position	vertical
Power dissipation	26.3 W
Power dissipation single housing for 30 °C	
Ambient temperature	30 °C
Reduction factor	0.82
Mounting position	vertical
Power dissipation	21.6 W
Power dissipation single housing for 40 °C	
Ambient temperature	40 °C
Reduction factor	0.62
Mounting position	vertical
Power dissipation	16.3 W
D	
Power dissipation single housing for 50 °C	50 °C
Ambient temperature	50 °C
Reduction factor	0.46
Mounting position	vertical
Power dissipation	12.1 W
Power dissipation single housing for 60 °C	
Ambient temperature	60 °C
Reduction factor	0.3
Mounting position	vertical
Power dissipation	7.9 W
Vibration test	
Specification	IEC 60068-2-6:2007-12
Frequency	10 - 150 - 10 Hz
Sweep speed	1 octave/min
Amplitude	0.15 mm (10 Hz 58.1 Hz)
Acceleration	2g (58.1 Hz 150 Hz)
Test duration per axis	2.5 h
Test directions	X-, Y- and Z-axis
Glow-wire test	
Specification	IEC 60695-2-11:2014-02
Temperature	850 °C
Time of exposure	30 s
·	
Thermal stability / ball thrust test	
Specification	IEC 60695-10-2:2014-02
Temperature	125 °C
Test duration	1 h
Force	20 N



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Specification	IEC 60068-2-31:2008-05
Height of fall	50 cm
Frequency	50
Shocks	
Specification	IEC 60068-2-27:2008-02
Pulse shape	Semi-sinusoidal
Acceleration	15g
Shock duration	11 ms
Number of shocks per direction	3
Test directions	X-, Y- and Z-axis (pos. and neg.)
Test for substances that would hinder coating with paint or	varnish
Specification	VDMA 24364:2018-05
Degree of protection (IP code)	IEC 60529:1989-11 + AMD 1:1999-11 + AMD 2:2013-08
Specification	IEC 60529:1989-11 + AMD 1:1999-11 + AMD 2:2013-08
Ambient conditions	
Max. IP code to attain	IP20
Ambient temperature (operation)	-40 °C 105 °C (depending on power dissipation)
Ambient temperature (storage/transport)	-40 °C 55 °C
Ambient temperature (assembly)	-5 °C 100 °C
Relative humidity (storage/transport)	80 %
CB data	
Number of PCB holders	4
Type of PCB mount	Latching
Total PCB surface	26000 mm²
Thickness of the PCB	1.4 mm 1.8 mm
ounting	
Mounting type	DIN rail mounting
Mounting position	Vertical (horizontal DIN rail)
ackaging specifications	
Type of packaging	packed in cardboard
Outer packaging type	Carton
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Classifications

ECLASS

	ECLASS-11.0	27182702	
	ECLASS-13.0	27190601	
ΕT	ETIM		
	ETIM 9.0	EC001031	
UNSPSC			
	UNSPSC 21.0	31261500	



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Environmental product compliance

China RoHS	Environmentally friendly use period: unlimited = EFUP-e
	No hazardous substances above threshold values

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